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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.: 10/777,688

Filed: February 12, 2004

Inventor(s):

Andreas Huschka, Wolfram

Kluge, and Uwe Hahn

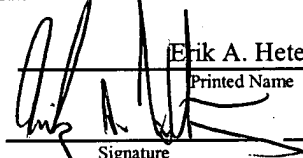
Title: SEMICONDUCTOR DIE  
PACKAGE HAVING TWO  
DIES PADDLES

Examiner: Hoai V Pham

Group/Art Unit: 2814

Atty. Dkt. No: 5500-79302

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date indicated below.

  
Erik A. Heter  
Printed Name  
2/2/06  
Date

RESPONSE TO OFFICE ACTION OF  
November 2, 2005

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

This paper is submitted in response to the Office Action of November 2, 2005, to further highlight why the application is in condition for allowance.

Please amend the case as listed below.